

PRODUCT RELIABILITY REPORT FOR

MAXQ314, Rev A2

Maxim Integrated Products

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Prepared by:

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Conclusion:

The following qualification successfully meets the quality and reliability standards required of all Maxim products:

In addition, Maxim's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at http://www.maxim-ic.com/TechSupport /dsreliability.html.

Device Description:

A description of this device can be found in the product data sheet. You can find the product data sheet at http://dbserv.maxim-ic.com/l_datasheet3.cfm.

Reliability Derating:

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

```
AfT = exp((Ea/k)*(1/Tu - 1/Ts)) = tu/ts
AfT = Acceleration factor due to Temperature
tu = Time at use temperature (e.g. 55°C)
ts = Time at stress temperature (e.g. 125°C)
k = Boltzmann's Constant (8.617 x 10-5 eV/°K)
Tu = Temperature at Use (°K)
Ts = Temperature at Stress (°K)
Ea = Activation Energy (e.g. 0.7 ev)
```

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7ev will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

```
AfV = exp(B*(Vs - Vu))

AfV = Acceleration factor due to Voltage

Vs = Stress Voltage (e.g. 7.0 volts)

Vu = Maximum Operating Voltage (e.g. 5.5 volts)

B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)
```

The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

```
Fr = X/(ts * AfV * AfT * N * 2)
X = Chi-Sq statistical upper limit
N = Life test sample size
```

Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

MTTF = 1/Fr

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

FAILURE RATE: MTTF (YRS): 23512 FITS: 4.9

DEVICE HOURS: 188725441 FAILS: 0

Only data from Operating Life or similar stresses are used for this calculation.

The parameters used to calculate this failure rate are as follows:

Cf: 60% Ea: 0.7 B: 0 Tu: 25 °C Vu: 3.6 Volts

The reliability data follows. At the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available and may contain some generic data. **Bold** Product Number denotes specific product data.

Device Information:

Process: Maxim X3 Fab S45 0.4um CBiCMOS Technology with 3V & 5V CMOS

devices

Passivation: SiN / SiO2
Die Size: 100 x 102
Number of Transistors: 152981

Interconnect: Aluminum / 0.5% Copper

Gate Oxide Thickness: 140Å

ESD HBM									
DESCRIPTION	DATE COD	E/PRODUCT/L	.ОТ	CONDITION	READ	POIN	QTY	FAILS	FA#
ESD SENSITIVITY	0932 MA	XQ314 (QJ991300AB	JESD22-A114 HBM 500 VOLTS	1	PUL'S	3	0	
ESD SENSITIVITY	0932 MA	XQ314 (QJ991300AB	JESD22-A114 HBM 1000 VOLTS	1	PUL'S	3	0	
ESD SENSITIVITY	0932 MA	XQ314 (QJ991300AB	JESD22-A114 HBM 2000 VOLTS	1	PUL'S	3	0	
ESD SENSITIVITY	0932 MA	XQ314 (QJ991300AB	JESD22-A114 HBM 4000 VOLTS	1	PUL'S	3	0	
ESD SENSITIVITY	0932 MA	XQ314 (QJ991300AB	JESD22-A114 HBM 8000 VOLTS	1	PUL'S	3	3	No FA
					Total:			3	
LATCH-UP									
DESCRIPTION	DATE COD	E/PRODUCT/L	.ОТ	CONDITION	READ	POIN	QTY	FAILS	FA#
LATCH-UP I	0932 MAX	XQ314 (QJ991300AB	JESD78A, I-TEST 125C			6	0	
LATCH-UP V	0932 MA	XQ314 (QJ991300AB	JESD78A, V-SUPPLY TEST 125C			6	0	
					Total:			0	
OPERATING LIFE									
DESCRIPTION	DATE CODE/PRODUCT/LOT			CONDITION	READ	POIN	QTY	FAILS	FA#

FAILURE RATE:		MTTF (YRS):	23	512	FITS:	4.9			
						Total:			0
HIGH TEMP OP LIFE	0932	MAXQ314	QJ991300AB	125C, 3.6	VOLTS	192	HRS	45	0
HIGH TEMP OP LIFE	0835	DS8500	QJ982700AB	125C, 3.6	VOLTS	1000	HRS	45	0
HIGH TEMP OP LIFE	0819	DS2733	XJ881600BB-	125C, 13. 3.5V (PS/	` '	1000	HRS	45	0
HIGH TEMP OP LIFE	0816	DS4560	QD836692AB	100C, 13. (PSA)	2V (PSB) & 5.5V	1000	HRS	45	0
HIGH TEMP OP LIFE	0812	DS8102	QJ880400AB	125C, 3.6	VOLTS	1000	HRS	45	0
HIGH TEMP OP LIFE	0708	DS2731	XK664400AD	125C, 4.9 (PSB)	V (PSA) & 13.2V	1000	HRS	45	0

DEVICE HOURS: 188725441 FAILS: 0